Problem 1

```
a.
P1. 3.2GHz \div 1.5 = 2.13 \times 10^9 instructions per second
P2. 2.0GHz \div 1.0 = 2.0 \times 10^9 instructions per second
P3. 4.0GHz \div 2.3 = 1.74 \times 10^9 instructions per second
b.
P1.
3.2GHz \times 10s = 3.2 \times 10^{10} cycles
3.2GHz \div 1.5 = 2.13 \times 10^{10} instructions
P2.
3.2GHz \times 10s = 2.0 \times 10^{10} cycles
2.0GHz \div 1.0 = 2.0 \times 10^9 instructions
P3.
4.0GHz \times 10s = 1.74 \times 10^{10} cycles
4.0GHz \div 2.3 = 1.74 \times 10^9 instructions
c.
execution time = (number of instructions \times CPI) \div clockrate
new clockrate = 1.71 \times clockrate
P1:3.2 \times 1.71 = 5.47GHz
P2: 2.0 \times 1.71 = 3.42GHz
P3: 4.0 \times 1.71 = 6.84GHz
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Problem 2

a.
$$A = (1 \times 10^6) \times 30\% = 3 \times 10^5$$

$$B = (1 \times 10^6) \times 20\% = 2 \times 10^5$$

$$C = (1 \times 10^6) \times 30\% = 3 \times 10^5$$

$$P1 = 2.2 \times 10^6 \div 1 \times 10^6 = 2.2$$

$$P2 = 2.0 \times 10^6 \div 1 \times 10^6 = 2.0$$
b.
$$P1 = (1 \times 3 \times 10^5) + (2 \times 2 \times 10^5) + (3 \times 2 \times 10^5) = 2.2 \times 10^6$$

$$P1 = (2 \times 3 \times 10^5) + (2 \times 2 \times 10^5) + (2 \times 2 \times 10^5) = 2.0 \times 10^6$$

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c. P1: (2.2 \times 10^6) \div 2.5 \times 10^9 = .88ms
P2: (2.0 \times 10^6) \div 3 \times 10^9 = .88ms
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Problem 3

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a. A = 1.2 \div (109 \times 109) = 1.2

B = 1.5 \div (1.2 \times 109 \times 109) = 1.25

b. Clock speed A = (109 \times 1.2 \times ClockspeedB) \div (1.2 \times 109 \times 1.25)

ClockspeedA = .8 \times ClockspeedB

A'sClockspeedis20\%slowerthanB's

c. C: 6.0 \times 1.1 \times 108 \times 109 = .66s

A: 1.2 \times A = .66 \times C

1.82 \times A = C

Cis1.82timesfasterthanA

B: 1.5 \times B = .66 \times C

2.27 \times B = C

Cis2.27timesfasterthanB
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Problem 4

```
a. Yield of Wafer 1 = 1 \div (1 + .022 \times .5 \times 2.10)^2 = .959 Yield of Wafer 2 = 1 \div (1 + .031 \times .5 \times \pi)^2 = .909 b) Cost of Wafer 1 = 12 \div (84 \times .959) = \$.15 CostofWafer2 = 15 \div (100 \times .909) = \$.16 c) AreaofWafer1 = 2.10 \div (1.1 \times 84) = 1.91cm<sup>2</sup> Yield of Wafer 1 = 1 \div (1 + 1.15 \times .022 \times .5 \times 1.91)^2 = .957
```

Area of Wafer
$$2 = \pi \div (1.1 \times 100) = 2.86 cm^2$$

Yield of Wafer $2 = 1 \div (1 + 1.15 \times .031 \times .5 \times 2.86)^2 = .905$

Problem 5

```
(50 \times 10^6 \times .6 \times 2) + (100 \times 10^6 \times .6 \times 2) + (80 \times 10^6 \times .7 \times 8) + (16 \times 10^6 \times .7 \times 4) \div 2GHz =
  336.4 \times 10^6
336.4 \times 10^6 \div 502 \times 10^6 = .67
33% faster execution time
b.
.95 \times 502 \times 10^6 = ((50 \times 10^6 \times \text{new CPI}) + (100 \times 10^6 \times 2) + (80 \times 10^6 \times 8) + (16 \times 10^6 \times 1
10^6 \times 4)) \div 2GHz
new CPI = .996
c. .70 \times 502 \times 10^6 = ((50 \times 10^6 \times 2) + (100 \times 10^6 \times 2) + (80 \times 10^6 \times \text{new CPI}) + (16 \times 10^6 
\times 10^6 \times 4)) \div 2GHz
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new CPI must be improved 4.235 for the program to be 30% faster